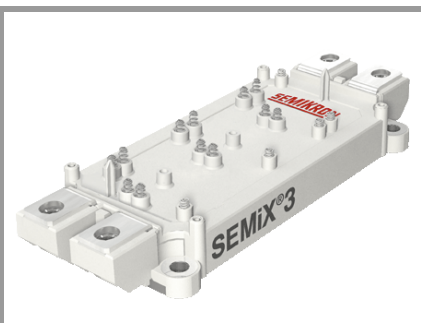


SEMiX453GB12T4s



SEMiX[®]3s

Trench IGBT Modules

SEMiX453GB12T4s

Features

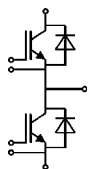
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability
- UL recognised file no. E63532

Typical Applications

- AC inverter drives
- UPS
- Electronic Welding

Remarks

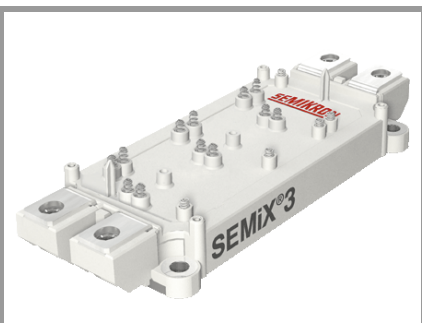
- Case temperature limited to $T_C=125^\circ\text{C}$ max.
- Product reliability results are valid for $T_j=150^\circ\text{C}$
- Dynamic values apply to the following combination of resistors:
 $R_{Gon,main} = 1,0 \Omega$
 $R_{Goff,main} = 1,0 \Omega$
 $R_{G,X} = 2,2 \Omega$
 $R_{E,X} = 0,5 \Omega$



GB

| Absolute Maximum Ratings | | | | |
|--------------------------|---|--------------------------|-------------|------------------|
| Symbol | Conditions | | Values | Unit |
| IGBT | | | | |
| V_{CES} | | | 1200 | V |
| I_C | $T_j = 175^\circ\text{C}$ | $T_c = 25^\circ\text{C}$ | 683 | A |
| | | $T_c = 80^\circ\text{C}$ | 526 | A |
| I_{Cnom} | | | 450 | A |
| I_{CRM} | $I_{CRM} = 3 \times I_{Cnom}$ | | 1350 | A |
| V_{GES} | | | -20 ... 20 | V |
| t_{psc} | $V_{CC} = 800\text{ V}$ $V_{GE} \leq 20\text{ V}$ $T_j = 150^\circ\text{C}$ $V_{CES} \leq 1200\text{ V}$ | 10 | | μs |
| | | | | |
| T_j | | | -40 ... 175 | $^\circ\text{C}$ |
| Inverse diode | | | | |
| I_F | $T_j = 175^\circ\text{C}$ | $T_c = 25^\circ\text{C}$ | 544 | A |
| | | $T_c = 80^\circ\text{C}$ | 407 | A |
| I_{Fnom} | | | 450 | A |
| I_{FRM} | $I_{FRM} = 3 \times I_{Fnom}$ | | 1350 | A |
| I_{FSM} | $t_p = 10\text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$ | | | A |
| T_j | | | -40 ... 175 | $^\circ\text{C}$ |
| Module | | | | |
| $I_{t(RMS)}$ | | | 600 | A |
| T_{stg} | | | -40 ... 125 | $^\circ\text{C}$ |
| V_{isol} | AC sinus 50Hz, $t = 60\text{ s}$ | | 4000 | V |

| Characteristics | | | | | | |
|-----------------|--|---------------------------|------|------|-------|------------------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| IGBT | | | | | | |
| $V_{CE(sat)}$ | $I_C = 450\text{ A}$ $V_{GE} = 15\text{ V}$ chipelevel | $T_j = 25^\circ\text{C}$ | | 1.8 | 2.05 | V |
| | | $T_j = 150^\circ\text{C}$ | | 2.20 | 2.4 | V |
| V_{CE0} | | $T_j = 25^\circ\text{C}$ | | 0.8 | 0.9 | V |
| | | $T_j = 150^\circ\text{C}$ | | 0.7 | 0.8 | V |
| r_{CE} | $V_{GE} = 15\text{ V}$ | $T_j = 25^\circ\text{C}$ | | 2.2 | 2.6 | $\text{m}\Omega$ |
| | | $T_j = 150^\circ\text{C}$ | | 3.3 | 3.6 | $\text{m}\Omega$ |
| $V_{GE(th)}$ | $V_{GE}=V_{CE}, I_C = 18\text{ mA}$ | | 5 | 5.8 | 6.5 | V |
| I_{CES} | $V_{GE} = 0\text{ V}$ $V_{CE} = 1200\text{ V}$ | $T_j = 25^\circ\text{C}$ | | 0.1 | 0.3 | mA |
| | | $T_j = 150^\circ\text{C}$ | | | | mA |
| C_{ies} | $V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$ | $f = 1\text{ MHz}$ | | 27.9 | | nF |
| C_{oes} | | $f = 1\text{ MHz}$ | | 1.74 | | nF |
| C_{res} | | $f = 1\text{ MHz}$ | | 1.53 | | nF |
| Q_G | $V_{GE} = -8\text{ V...} + 15\text{ V}$ | | | 2550 | | nC |
| R_{Gint} | $T_j = 25^\circ\text{C}$ | | | 1.67 | | Ω |
| $t_{d(on)}$ | $V_{CC} = 600\text{ V}$ | | | 305 | | ns |
| t_r | $I_C = 450\text{ A}$ $T_j = 150^\circ\text{C}$ | | | 80 | | ns |
| E_{on} | $R_{Gon} = 1.9\ \Omega$ | | | 45 | | mJ |
| $t_{d(off)}$ | $R_{Goff} = 1.9\ \Omega$ | | | 535 | | ns |
| t_f | $di/dt_{on} = 4000\text{ A}/\mu\text{s}$ | | | 100 | | ns |
| E_{off} | $di/dt_{off} = 5000\text{ A}/\mu\text{s}$ | | | 50 | | mJ |
| $R_{th(j-c)}$ | per IGBT | | | | 0.065 | K/W |



SEMiX[®]3s

Trench IGBT Modules

SEMiX453GB12T4s

Features

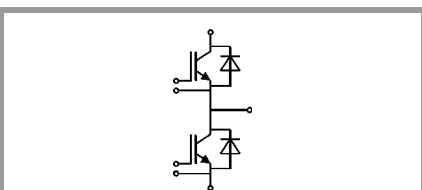
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GB

| Characteristics | | | | | | |
|---------------------------|--|---------------------------|------|--------------------|------|---------------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| Inverse diode | | | | | | |
| $V_F = V_{EC}$ | $I_F = 450 \text{ A}$ $V_{GE} = 0 \text{ V}$ chipllevel | $T_j = 25^\circ\text{C}$ | | 2.1 | 2.5 | V |
| | | $T_j = 150^\circ\text{C}$ | | 2.1 | 2.4 | V |
| V_{F0} | | $T_j = 25^\circ\text{C}$ | 1.1 | 1.3 | 1.5 | V |
| | | $T_j = 150^\circ\text{C}$ | 0.7 | 0.9 | 1.1 | V |
| r_F | | $T_j = 25^\circ\text{C}$ | 1.4 | 1.9 | 2.1 | m Ω |
| | | $T_j = 150^\circ\text{C}$ | 2.2 | 2.6 | 2.8 | m Ω |
| I_{RRM} | $I_F = 450 \text{ A}$ | $T_j = 150^\circ\text{C}$ | | 350 | | A |
| Q_{rr} | $di/dt_{off} = 5000 \text{ A}/\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | | 70 | | μC |
| E_{rr} | $V_{GE} = -15 \text{ V}$ $V_{CC} = 600 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 28 | | mJ |
| $R_{th(j-c)D}$ | per diode | | | | 0.11 | K/W |
| Module | | | | | | |
| L_{CE} | | | | 20 | | nH |
| $R_{CC'+EE'}$ | res., terminal-chip | $T_C = 25^\circ\text{C}$ | | 0.7 | | m Ω |
| | | $T_C = 125^\circ\text{C}$ | | 1 | | m Ω |
| $R_{th(c-s)}$ | per module | | | 0.04 | | K/W |
| M_s | to heat sink (M5) | | 3 | | 5 | Nm |
| M_t | to terminals (M6) | | 2.5 | | 5 | Nm |
| w | | | | | 300 | g |
| Temperature sensor | | | | | | |
| R_{100} | $T_C=100^\circ\text{C}$ ($R_{25}=5 \text{ k}\Omega$) | | | 0,493 $\pm 5\%$ | | k Ω |
| $B_{100/125}$ | $R_{(T)}=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]$; $T[\text{K}]$; | | | 3550 $\pm 2\%$ | | K |

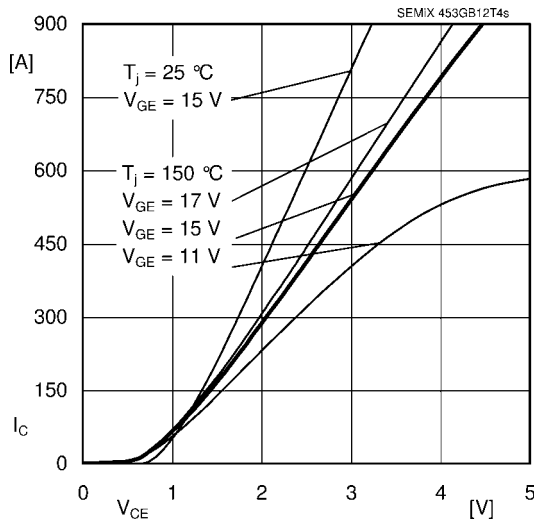


Fig. 1 Typ. output characteristic, inclusive $R_{CC'+EE'}$

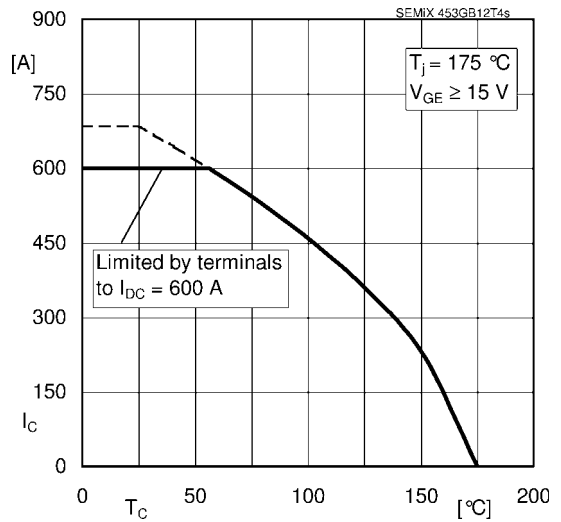


Fig. 2 Rated current vs. temperature $I_C = f(T_C)$

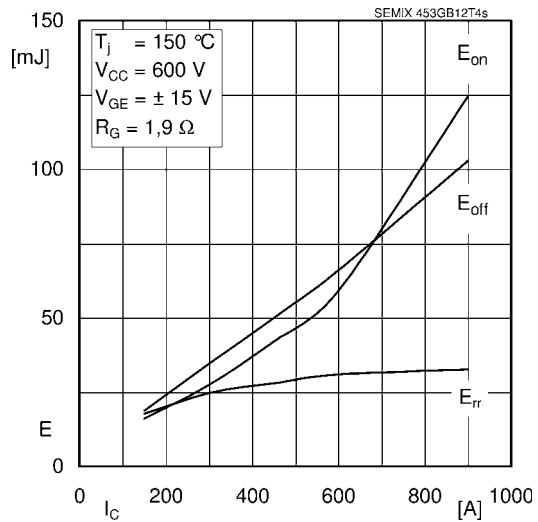


Fig. 3 Typ. turn-on /-off energy = $f(I_C)$

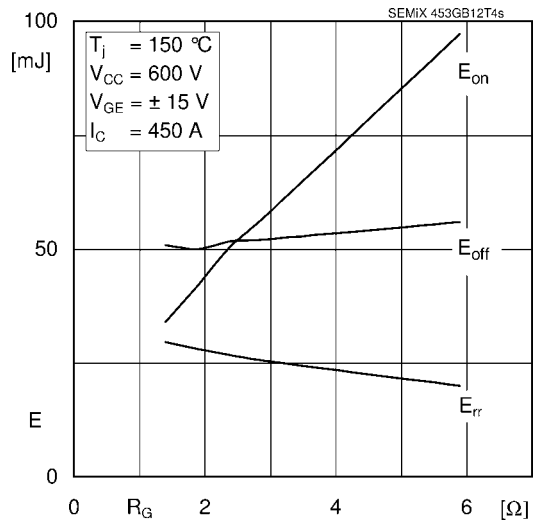


Fig. 4 Typ. turn-on /-off energy = $f(R_G)$

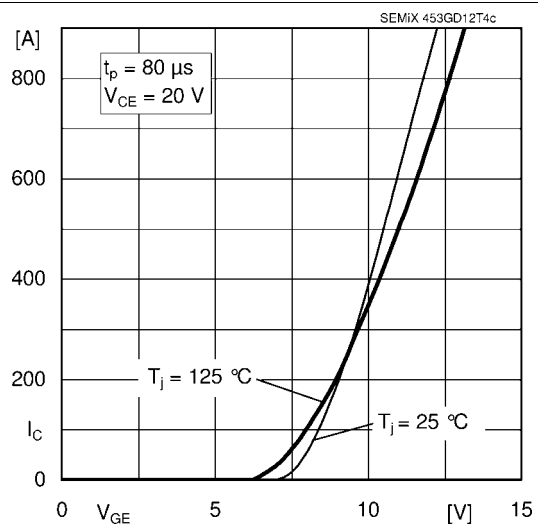


Fig. 5 Typ. transfer characteristic

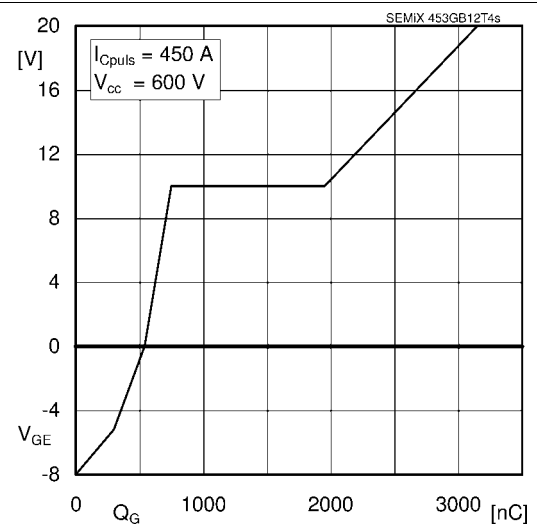


Fig. 6 Typ. gate charge characteristic

